

# Low Voltage Hex Inverter with Schmitt Trigger Input

# **74LVX14**

# **General Description**

The LVX14 contains six inverter gates each with a Schmitt trigger input. They are capable of transforming slowly changing input signals into sharply defined, jitter–free output signals. In addition, they have a greater noise margin than conventional inverters.

The LVX14 has hysteresis between the positive-going and negative-going input thresholds (typically 1.0 V) which is determined internally by transistor ratios and is essentially insensitive to temperature and supply voltage variations.

The inputs tolerate voltages up to 6.5 V allowing the interface of 5 V systems to 3 V systems.

#### **Features**

- Input Voltage Level Translation From 5 V to 3 V
- Ideal For Low Power/Low Noise 3.3 V Applications
- Guaranteed Simultaneous Switching Noise Level and Dynamic Threshold Performance
- These Devices are Pb-Free and Halide Free

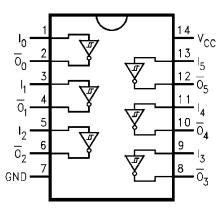


Figure 1. Connection Diagram

### **PIN DESCRIPTION**

Pin Names	Description
In	Inputs
$\overline{O}_n$	Outputs

# TRUTH TABLE

Input	Output
Α	ō
L	Н
Н	L

1



TSSOP-14 DT SUFFIX CASE 948G

#### **MARKING DIAGRAM**



XXX = Specific Device Code A = Assembly Location

WL, L = Wafer Lot Y = Year Ww, W = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 3 of this data sheet.

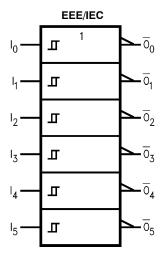


Figure 2. Logic Symbol

#### 74LVX14

# ABSOLUTE MAXIMUM RATINGS (The absolute maximum ratings are stress ratings only.)

Symbol	Parameter	Rating
V <sub>CC</sub>	Supply Voltage	-0.5 V to +6.5 V
I <sub>IK</sub>	DC Input Diode Current, V <sub>I</sub> = -0.5 V	–20mA
VI	DC Input Voltage	–0.5 V to 6.5 V
Іок	DC Output Diode Current $V_0 = -0.5 \text{ V}$	–20 mA
	$V_{O} = V_{CC} + 0.5 V$	+20 mA
Vo	DC Output Voltage	-0.5 V to V <sub>CC</sub> $+0.5$ V
I <sub>O</sub>	DC Output Source or Sink Current	±25 mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current	±50 mA
T <sub>STG</sub>	Storage Temperature	−65°C to +150°C
P <sub>D</sub>	Power Dissipation	833 mW

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

# **RECOMMENDED OPERATING CONDITIONS (Note 1)**

Symbol	Parameter	Rating
V <sub>CC</sub>	Supply Voltage	2.0 V to 3.6 V
VI	Input Voltage	0 V to 5.5 V
V <sub>O</sub>	Output Voltage	0 V to V <sub>CC</sub>
T <sub>A</sub>	Operating Temperature	-40°C to +85°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

# **DC CHARACTERISTICS**

					T <sub>A</sub> = +25°C	•	T <sub>A</sub> = −40°	C to 85°C	
Symbol	Parameter	V <sub>CC</sub>	Conditions	Min	Тур	Max	Min	Max	Unit
V <sub>T+</sub>	Positive Threshold	3.0	-	-	-	2.2	-	2.2	V
V <sub>T-</sub>	Negative Threshold	3.0	-	0.9	-	-	0.9	-	V
V <sub>H</sub>	Hysteresis	3.0	-	0.3	-	1.2	0.3	1.2	V
V <sub>OH</sub>	HIGH Level Output	2.0	$V_{IN} = V_{IL}$ or $V_{IH}$ , $I_{OH} = -50 \mu A$	1.9	2.0	-	1.9	-	V
	Voltage	3.0	$V_{IN} = V_{IL}$ or $V_{IH}$ , $I_{OH} = -50 \mu A$	2.9	3.0	-	2.9	-	
			$V_{IN} = V_{IL}$ or $V_{IH}$ , $I_{OH} = -4$ mA	2.58	_	_	2.48	-	
V <sub>OL</sub>	LOW Level Output	2.0	$V_{IN} = V_{IL}$ or $V_{IH}$ , $I_{OH} = 50 \mu A$	_	0.0	0.1	_	0.1	V
	Voltage	3.0	$V_{IN} = V_{IL}$ or $V_{IH}$ , $I_{OH} = 50 \mu A$	_	0.0	0.1	_	0.1	
			V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OH</sub> = 4 mA	-	-	0.36	_	0.44	
I <sub>IN</sub>	Input Leakage Current	3.6	V <sub>IN</sub> = 5.5 V or GND	_	-	±0.1	-	±1.0	μΑ
I <sub>CC</sub>	Quiescent Supply Current	3.6	V <sub>IN</sub> = V <sub>CC</sub> or GND	-	-	2.0	-	0	μΑ

<sup>1.</sup> Unused inputs must be held HIGH or LOW. They may not float.

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# NOISE CHARACTERISTICS (Note 2)

				T <sub>A</sub> = 25°C		
Symbol	Parameter	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Тур	Limits	Unit
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	3.3	50	0.3	0.5	V
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	3.3	50	-0.3	-0.5	V
V <sub>IHD</sub>	Minimum HIGH Level Dynamic Input Voltage	3.3	50	-	2.0	V
$V_{ILD}$	Maximum LOW Level Dynamic Input Voltage	3.3	50	-	0.8	V

<sup>2.</sup> Input  $t_r = t_f = 3 \text{ ns.}$ 

#### **AC ELECTRICAL CHARACTERISTICS**

				T <sub>A</sub> = +25°C		T <sub>A</sub> = -40°C to 85°C			
Symbol	Parameter	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay Time	2.7	15 50	-	8.7 11.2	16.3 19.8	1.0 1.0	19.5 23.0	ns
		3.3 ±0.3	15 50	-	6.8 9.3	10.6 14.1	1.0 1.0	12.5 16.0	
T <sub>OSLH</sub> ,	Output to Output Skew (Note 3)	2.7	50	-	-	1.5	ı	1.5	ns
toshl		3.3		-	-	1.5	_	1.5	

<sup>3.</sup> Parameter guaranteed by design  $t_{OSLH} = |t_{PLHm} - t_{PLHn}|$ ,  $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$ .

# **CAPACITANCE**

		T <sub>A</sub> = +25°C		T <sub>A</sub> = -40°C to 85°C			
Symbol	Parameter	Min	Тур	Max	Min	Max	Unit
C <sub>IN</sub>	Input Capacitance	-	4	10	-	10	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 4)	-	21	-	-	-	pF

<sup>4.</sup> C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:

(eq. 1) 
$$I_{CC(opr.)} = \frac{C_{PD} \times V_{CC} \times f_{IN} \times I_{CC}}{6 \text{ (per Gate)}}$$

#### **ORDERING INFORMATION**

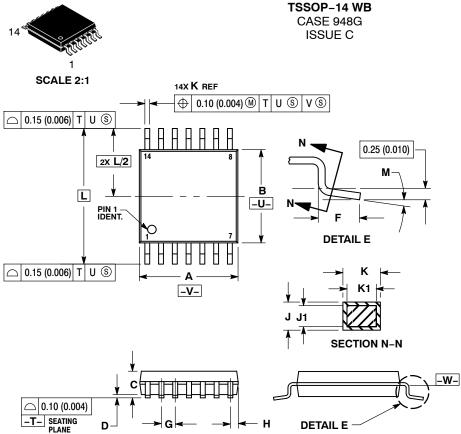
Part Number	Package	Marking	Shipping <sup>†</sup>
74LVX14MTCX	TSSOP-14	LVX 14	2500 Units / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <a href="https://example.com/BRD8011/D">BRD8011/D</a>.

<sup>\*-</sup>Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

**DATE 17 FEB 2016** 





- NOTES.

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSION A DOES NOT INCLUDE MOLD
- FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  DIMENSION B DOES NOT INCLUDE
- INTERLEAD FLASH OR PROTRUSION.
  INTERLEAD FLASH OR PROTRUSION SHALL
- INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

  DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.

  TERMINAL NUMBERS ARE SHOWN FOR DEEEDENIC OMITY.
- REFERENCE ONLY.
  DIMENSION A AND B ARE TO BE
- DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.90	5.10	0.193	0.200
В	4.30	4.50	0.169	0.177
С		1.20		0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65	BSC	0.026	BSC
Н	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40	BSC	0.252	BSC
М	0°	8 °	0 °	8 °

# **GENERIC MARKING DIAGRAM\***



= Assembly Location

L = Wafer Lot = Year

= Work Week W = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

# **RECOMMENDED SOLDERING FOOTPRINT\***

<b>-</b>	7.06
1	
	-
	U 0.65 PITCH
<b>↓</b> □	The state of the s
14X 0.36	<del></del>
0.36 - 1.26	DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	TSSOP-14 WB		PAGE 1 OF 1			

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